

FDD390N15ALZ N-Channel PowerTrench[®] MOSFET 150 V, 26 A, 42 mΩ

Features

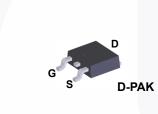
- R_{DS(on)} = 33.4 mΩ (Typ.) @ V_{GS} = 10 V, I_D = 26 A
- R_{DS(on)} = 42.2 mΩ (Typ.) @ V_{GS} = 4.5 V, I_D = 20 A
- Fast Switching Speed
- Low Gate Charge, Q_G = 17.6 nC (Typ.)
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- · High Power and Current Handling Capability
- RoHS Compliant

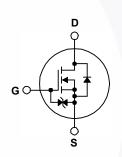
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Consumer Applicances
- LED TV
- Synchronous Rectification
- Uninterruptible Power Supplies
- Micro Solar Inverter





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

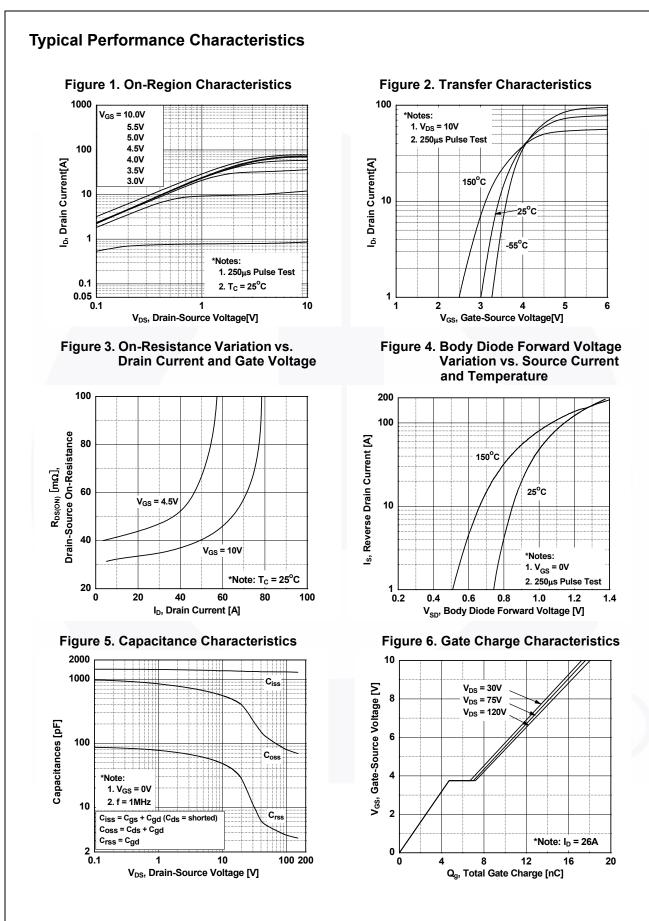
Symbol	Parameter		FDD390N15ALZ	Unit	
V _{DSS}	Drain to Source Voltage		150	V	
V _{GSS}	Gate to Source Voltage		±20	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)	26	•	
	Drain Current	- Continuous (T _C = 100 ^o C)	17	A	
I _{DM}	Drain Current	- Pulsed (Note 1)	104	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		96	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		13	V/ns	
P _D	Dewer Dissignation	(T _C = 25°C)	63	W	
	Power Dissipation	- Derate Above 25°C	0.5	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperatur	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		°C	

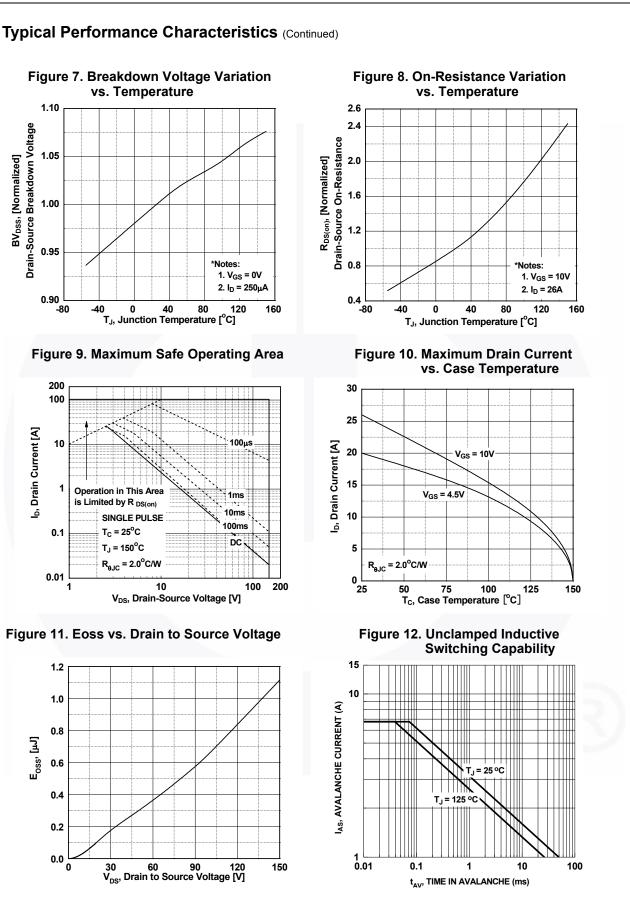
Thermal Characteristics

Symbol	Parameter	FDD390N15ALZ	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	87	°C/W

Part Nur	Part Number Top Mark Pa		Package	Packing Methe	od Reel Size	Тар	e Width	Qua	ntity
FDD390N ²	15ALZ	FDD390N15ALZ	DPAK	Tape and Ree	el 330 mm	1	6 mm	2500 units	
Electrica	I Chai	racteristics T _C = 2	5 ^o C unless of	herwise noted.					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	cs							
BV _{DSS}	Drain to Source Breakdown Voltage		age	I _D = 250 μA, V _{GS} = 0 V		150	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		-	$I_D = 250 \ \mu$ A, Referenced to 25° C		-	0.15	-	V/ºC
IDSS	Zero G	Zero Gate Voltage Drain Current		V _{DS} = 120 V, V _{GS} =		-	-	1	μA
		-		V _{DS} = 120 V, T _C =		-	-	500	
I _{GSS}	Gate to	o Body Leakage Current	ľ	V _{GS} = ±20 V, V _{DS} =	= 0 V	-	-	±10	μA
On Charac	teristic	s							
V _{GS(th)}	Gate T	hreshold Voltage		V _{GS} = V _{DS} , I _D = 25		1.4	-	2.8	V
R _{DS(on)}	Static Drain to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 26 \text{ A}$			-	33.4	42	mΩ		
NDS(on)	Static	Static Drain to Source On Resistance		V _{GS} = 4.5 V, I _D = 20 A		-	42.2	64	mΩ
9 _{FS}	Forwar	rd Transconductance	'	V _{DS} = 10 V, I _D = 26 A		-	50	-	S
Dynamic C	haract	eristics							
C _{iss}		Capacitance		V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		-	1323	1760	pF
C _{oss}	Output	Capacitance				-	93	120	pF
C _{rss}	Revers	se Transfer Capacitance				-	4	6	pF
C _{oss(er)}	Energy	Related Output Capacita	ince	V _{DS} = 75 V, V _{GS} =	0 V	-	165	-	pF
Q _{g(tot)}	Total G	ate Charge at 10V	,	V _{GS} = 10 V	80		17.6	39	nC
Q _{g(tot)}	Total G	ate Charge at 5V	,	V _{GS} = 4.5 V			8.1	10.5	nC
Q _{gs}	Gate to	o Source Gate Charge					4.7	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge					2.3	-	nC
ESR	Equiva	lent Series Resistance (G	i-S)	f = 1 MHz		-	1.48	-	Ω
Switching	Charac	cteristics							
t _{d(on)}	1	n Delay Time				-	12.8	35.6	ns
t _r		n Rise Time		V_{DD} = 75 V, I _D = 26 A, V_{GS} = 10 V, R _G = 4. 7Ω (Note 4)		-	9.3	28.6	ns
t _{d(off)}	Turn-O	ff Delay Time				7-	26.9	63.8	ns
t _f	Turn-O	ff Fall Time				-	3.2	16.4	ns
								1	
		de Characteristics	ouroo Diodo	Forward Current				26	•
I _S	Maximum Continuous Drain to Source Dio					-	-	104	A
I _{SM}	Maximum Pulsed Drain to Source Diode F Drain to Source Diode Forward Voltage					-	-	1.25	V
V _{SD}		e Recovery Time		$V_{GS} = 0 V, I_{SD} = 26 A$ $V_{GS} = 0 V, I_{SD} = 26 A,$ $dI_{F}/dt = 100 A/\mu s$		-	70	1.25	ns
trr		e Recovery Charge				-	169		nC
Q _{rr}	1.00013	o noovery onarge					100		10

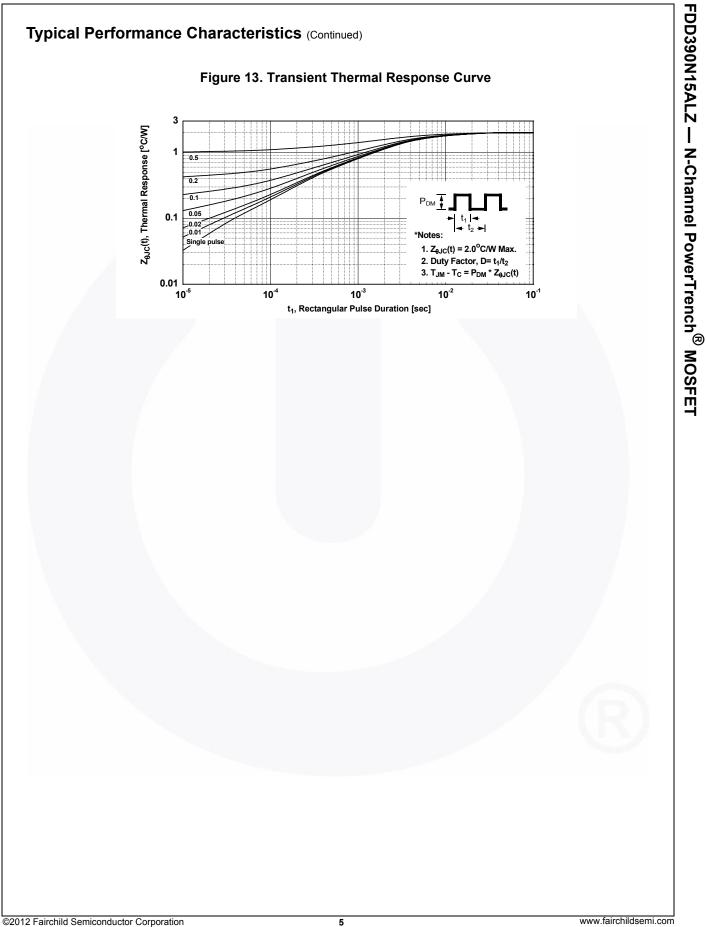


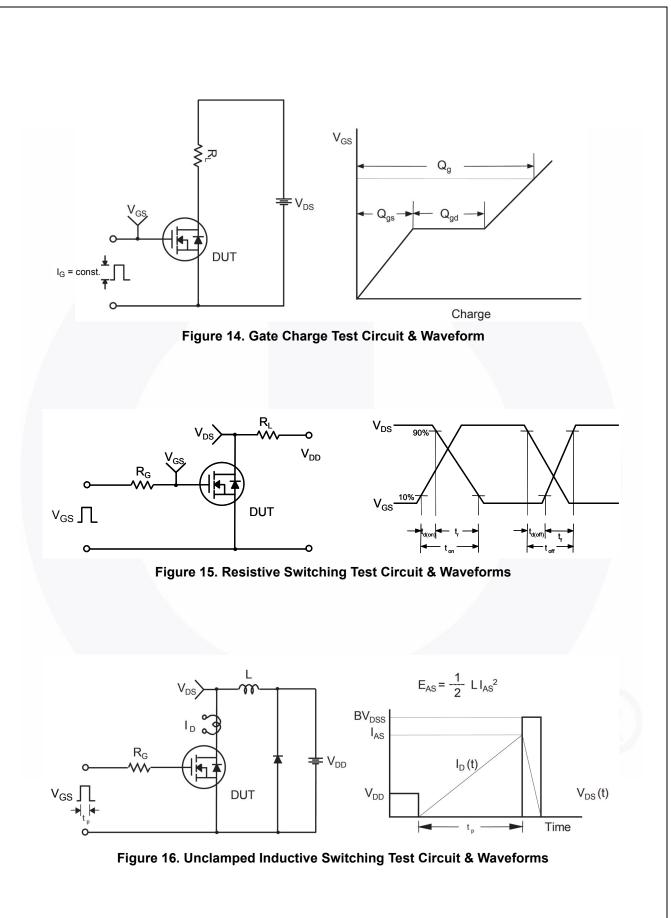




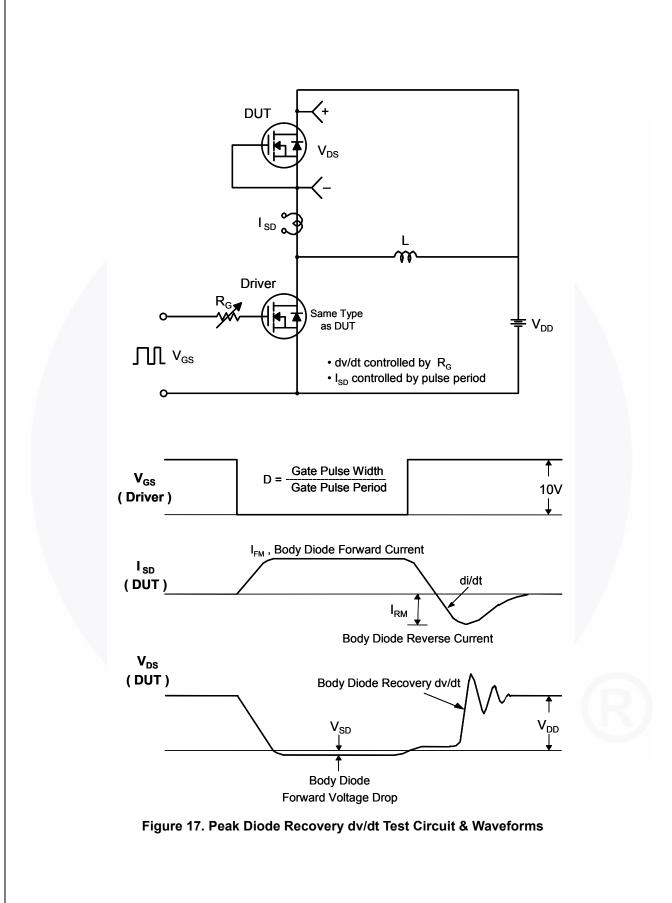
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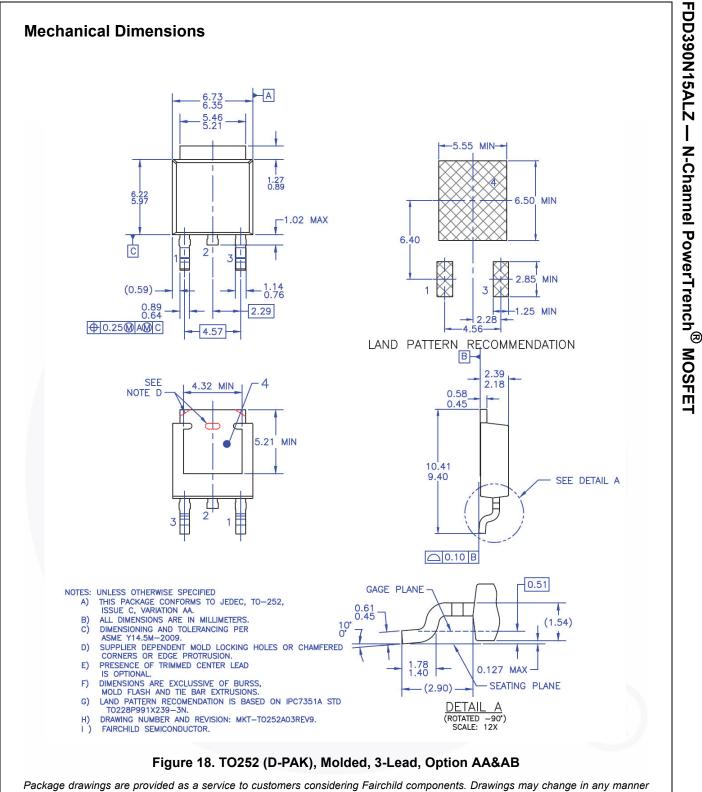




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